

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L2	200	(ni-re ni-p nickel-phosphorus nickel-rhenium ((nickel ni) near20 (Re rhenium phosphor\$6))) same (conductor metal\$3 copper cu) near9 (diffus\$5 migrat\$5) near3 (prevent\$5 barrier protect\$5)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/06 10:53
L3	200	(ni-re ni-p nickel-phosphorus nickel-rhenium ((nickel ni) near20 (Re rhenium phosphor\$6))) same (conductor metal\$3 copper cu) near9 (diffus\$5 migrat\$5) near3 (prevent\$5 barrier protect\$5)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/06 10:57
L4	200	(ni-re ni-p nickel-phosphorus nickel-rhenium ni-re-p ni-p nickel-rhenium-phosphorus nickel-rhenium ((nickel ni) near20 (Re rhenium phosphor\$6))) same (conductor metal\$3 copper cu) near9 (diffus\$5 migrat\$5) near3 (prevent\$5 barrier protect\$5)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/06 10:59
L5	23	(ni-re nickel-rhenium ni-re-p nickel-rhenium-phosphorus ((nickel ni) near20 (Re rhenium) near20 (p phosphor\$6))) same (conductor metal\$3 copper cu) near9 (diffus\$5 migrat\$5) near3 (prevent\$5 barrier protect\$5)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/06 11:00

L6	47	(ni-re nickel-rhenium ni-re-p nickel- rhenium-phosphorus ((nickel ni) near20 (Re rhenium) near20 (p phosphor\$6))) same (diffus\$5 migrat \$5) near3 (prevent\$5 barrier protect\$5)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/06 11:01
L7	739	(ni-re nickel-rhenium ni-re-p nickel- rhenium-phosphorus ((nickel ni) near20 (Re rhenium) near20 (p phosphor\$6))) same (diffus\$5 migrat \$5 prevent\$5 barrier protect\$5)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/06 11:03
L8	720	(ni-re-p nickel- rhenium-phosphorus ((nickel ni) near20 (Re rhenium) near20 (p phosphor\$6))) same (diffus\$5 migrat \$5 prevent\$5 barrier protect\$5)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/06 11:04
L9	129	(ni-re-p nickel- rhenium-phosphorus ((nickel ni) near20 (Re rhenium) near20 (p phosphor\$6))) same (diffus\$5 migrat \$5 barrier)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/06 11:04
L10	58	(ni-re-p nickel- rhenium-phosphorus ((nickel ni) near20 (Re rhenium) near20 (p phosphor\$6))) same (diffus\$5 migrat \$5 metal copper cu) near3 (prevent\$5 barrier protect\$5)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/06 11:13
L11	32	"410337"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/06 11:18

L12	39	(nickel-rhenium-phosphorus Ni\$1Re \$1P (nickel near20 rhenium near20 phosphor\$6)) same (diffus\$5 migrat\$5 metal copper cu) near3 (prevent\$5 barrier protect\$5)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/06 11:22
L13	102	(nickel-rhenium-phosphorus Ni\$1Re \$1P (nickel near20 rhenium near20 phosphor\$6)) and (semiconductor micro \$1electronic\$3 electronic circuit (printed near3 board) wafer electrical\$5) and (diffus\$5 migrat\$5 metal copper cu) near3 (prevent\$5 barrier protect\$5)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/06 11:26
L14	26	"3,417,389" "3,607,460"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/06 11:29
L15	105	9 and (semiconductor micro\$1electronic\$3 electronic circuit (printed near3 board) wafer electrical\$5)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/06 11:34
L16	5463	copper near3 diffusion near9 barrier	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/06 11:44
L17	31	(nickel-rhenium-phosphorus Ni\$1Re \$1P (nickel near20 rhenium near20 phosphor\$6)) and 16	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/06 11:45

L18	20880	(copper conduct\$4 metal) near20 diffusion near9 barrier	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/06 11:47
L19	67	(nickel-rhenium-phosphorus Ni\$1Re \$1P (nickel near20 rhenium near20 phosphor\$6)) and 18	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/06 11:47
L21	25	(copper conduct\$4 metal\$3) near20 diffusion near9 barrier same (re rhenium) near20 (nickel ni) near20 (p phosphorus)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/06 11:57
L22	109	(copper conduct\$4 metal\$3) near20 diffusion near9 barrier same (re rhenium) near20 (w tungsten)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/06 11:58
L23	25	(copper) near20 diffusion near9 barrier same (re rhenium) near20 (w tungsten)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/06 11:59
L24	5	(copper) near20 diffusion near9 barrier same ternary near3 nickel near alloy	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/06 12:01
L25	68	(copper) near20 diffusion near9 barrier same nickel near alloy	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/06 12:02
L26	46	(copper) near20 diffusion near9 barrier same (tungsten w) near20 (re rhenium)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/06 12:15

L36	161	(ni-re-p nickel-rhenium-phosphorus ((nickel ni) near20 (Re rhenium) near20 (p phosphor\$6))) and electroless near plating	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/06 12:53
L37	198	(ni-re-p nickel-rhenium-phosphorus Ni\$1Re\$1P ((nickel ni) near20 (Re rhenium) near20 (p phosphor\$6))) and electroless near plating	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/06 12:55
L38	36	"6180523"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/06 13:43

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